Second DRD3 questionaire

Dear Institution Leader

Please take a few minutes of your time to complete

the following questionnaire.

Acronyms:
WG = Working Group
WP = Work Package
CB = Collaboration Board
1 Name of the institution:
2 Address:
3 Country:

4 CB representative of the institution				
5 Email of the CB representative:				
6 Number of persons contributing to DRD3				
7 Give the Institution name and authors list for the DRD3 proposal (latex format is encouraged).				
Is your institute interested in the following WORKING GROUPS?				
8 WG1 Monolithic CMOS Sensors				
Question instructions: Select one answer				
○ yes ○ no				
9 WG2 Sensors for Tracking and Calorimetry				
Question instructions: Select one answer				
yes no				

10 WG3 Radiation damage and extreme fluences
Question instructions: Select one answer
yes no
11 WG4 Simulation
Question instructions: Select one answer
O yes O no
12 WG5 Characterization techniques, facilities
Question instructions: Select one answer
yes no
13 WG6 Wide bandgap and innovative sensor materials
Question instructions: Select one answer
O yes O no
14 WG7 Interconnect and device fabrication
Question instructions: Select one answer
O yes O no
15 WG8 Dissemination and outreach
Question instructions: Select one answer
O yes O no
yes ono Is your institute interested in the following WORK PACKAGES?

17 WP2: DMAPS Timing resolution
Question instructions: Select one answer
○ yes ○ no
18 WP3: DMAPS Readout architectures
Question instructions: Select one answer
○ yes ○ no
19 WP4: DMAPS Radiation tolerance
Question instructions: Select one answer
○ yes ○ no
20 WP5: 4D tracking with 3D sensors
Question instructions: Select one answer
O yes O no
21 WP6: 4D tracking with LGAD sensors
Question instructions: Select one answer
O yes O no
22 WP7: Extreme fluence - wide band-gap materials (SiC, GaN)
Question instructions: Select one answer
O yes O no
23 WP8: Extreme fluence - Diamond detectors
Question instructions: Select one answer
O yes O no

24 WP9: Extreme fluence - Silicon detectors
Question instructions: Select one answer
O yes O no
25 WP10: 3D integration - Fast and maskless interconnect
Question instructions: Select one answer
Question instructions. Select one answer
O yes O no
26 WP11: 3D Integration - in house post-processing for hybridization
Question instructions: Select one answer
O yes O no
27 WP12: Advanced interconnection techniques for detectors
Question instructions: Select one answer
O yes O no
28 WP13: 3D Integration - Mechanics and cooling
Question instructions: Select one answer
O yes O no
Is your institute interested in participating in DRD3 common projects?
Here are a few examples of past projects:
1) MPW-4,
2) Defect engineering PAD diodes mimicking the gain layer in LGADs,
3) SiC-LGAD

29	Common	Projects	

no

not sure